## onsemi

# MOSFET - SiC Power, Single N-Channel, TO247-4L

650 V, 44 m , 47 A

### NVH4L060N065SC1

#### Features

- Typ. R<sub>DS(on)</sub> = 44 m @ V<sub>GS</sub> = 18 V Typ. R<sub>DS(on)</sub> = 60 m @ V<sub>GS</sub> = 15 V
- Ultra Low Gate Charge (Qtot) = 74 nC)
- Low Capacitance (Ges= 133 pF)
- 100% Avalanche Tested
- AEC ïQ101 Qualified and PPAP Capable
- This Device is PbFree and is RoHS Compliant
- Typical Applications
- Automotive On Board Charger
- Automotive DC/DC Converter for EV/HEV

#### MAXIMUM RATINGS (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Param	eter		Symbol	Value	Unit
Drain ïto ïSource Voltage	;		V <sub>DSS</sub>	650	V
Gate ïto ïSource Voltage			V <sub>GS</sub>	ï8/+22	V
Recommended Operatio of Gate ito iSource Volta		T <sub>C</sub> < 175°C	V <sub>GSop</sub>	ï5/+18	V
Continuous Drain Current (Note 1)	Steady State	$T_C = 25^{\circ}C$	Ι <sub>D</sub>	47	A
Power Dissipation (Note 1)			P <sub>D</sub>	176	W
Continuous Drain Current (Note 1)	Steady State	T <sub>C</sub> = 100°C	۱ <sub>D</sub>	33	A
Power Dissipation (Note 1)			PD	88	W
Pulsed Drain Current (Note 2)	Т <sub>С</sub>	= 25°C	I <sub>DM</sub>	152	A
Operating Junction and S Range	Storage Te	emperature	T <sub>J</sub> , T <sub>stg</sub>	ï55 to +175	°C
Course Current (Dodu D	1 - 3				

Source Current (Body Diode)

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Max	Unit
Junction ïto ïCase ï Steady State (Note 1)	R <sub>JC</sub>	0.85	°C/W
Junction ïto ïAmbient ï Steady State (Note 1)	R <sub>JA</sub>	40	

#### ELECTRICAL CHARACTERISTICS ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain ïto ïSource Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA	650	ï	ï	V
Drain ïto ïSource Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	Ι <sub>D</sub>	-	-	-	

#### ELECTRICAL CHARACTERISTICS ( $T_J = 25^{\circ}C$ unless otherwise specified) (continued)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
DRAIN ïSOURCE DIODE CHARACTERIS	TICS					
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = ï5/18 V, I <sub>SD</sub> = 20 A, dI <sub>S</sub> /dt = 1000 A/ s	ï	17.7	ï	ns
Reverse Recovery Charge	Q <sub>RR</sub>	ai <sub>S</sub> /at = 1000 A/ s	ï	90.6	ï	nC
Reverse Recovery Energy	E <sub>REC</sub>		ï	8.7	ï	J
Peak Reverse Recovery Current	I <sub>RRM</sub>		ï	10.2	ï	А
Charge time	Та		ï	9.8	ï	ns
Discharge time	Tb		ï	7.8	ï	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### TYPICAL CHARACTERISTICS

		15	V		

 $V_{\text{DS}},$  DRAIN iTO iSOURCE VOLTAGE (V) Figure 1. On  $% \mathcal{T}_{\text{DS}}$  is a characteristics

$\mathbf{n}$					
	$\mathbf{\Lambda}$				


I<sub>D</sub>, DRAIN CURRENT (A)

Figure 2. Normalized On ïResistance vs. Drain Current and Gate Voltage


1			
1			
1			
1			
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#### TYPICAL CHARACTERISTICS

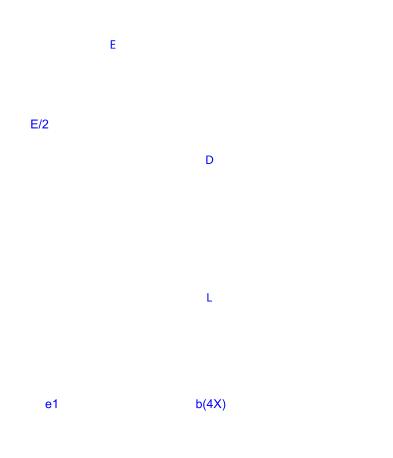
0.5 Duty Cycle	) <del>   </del>						-	-					+	H			t
																	Γ
0.2																	
0.1																	
0.05							_					₹					+
0.02								- - -	DN	1		-					Ē
		).01		+			_	-				+	-			-	-
Single Pulse								-				1		T			t

t, RECTANGULAR PULSE DURATION (sec)

Figure 13. Junction ito iCase Thermal Response

#### PACKAGE DIMENSIONS

TO ï247 ï4LD CASE 340CJ ISSUE A



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